


A cross-sectional diagram of a 4-layer PCB. The layers are labeled from top to bottom: L1 - COMPONENT SIDE, L2 - GND, L3 - GND, and L4 - BOTTOM. The diagram shows the physical structure of the layers and the placement of ground planes (GND) between them. The top layer (L1) is the component side, and the bottom layer (L4) is the bottom side. The ground planes (L2 and L3) are located between the signal layers.

LAYER CONSTRUCTION

UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN MILLIMETERS
TOLERANCES ON ANGLES $\pm 1^\circ$

.XX ± .25 .XXX ± .127	THIRD ANGLE PROJECTION	DRAWN	MEI	APPROVALS	DATE
		CHECKED			04/27/07
		APPROVED			
				W. GU	
DO NOT SCALE DRAWING		DESIGNED BY			

TOP BOTTOM



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TITLE
FAB, LTM8023EV, 2A DC/DC STEP-DOWN
POWER MODULE

SIZE	CAGE CODE	DWG NO.	REV
A		DC1195A	3
SCALE	1/1	FILENAME: 1195A-3.PCB	SHEET 1 OF 1

SHEET 1 OF 1